### Overview

### **HP ProBook 430 G6 Notebook PC**



#### Left

- 1. Internal Microphones (2)
- 2. Webcam
- 3. Webcam LED
- 4. Clickpad
- 5. Hard Drive LED

- 6. SD Card Reader
- 7. Thermal Vent
- 8. USB 3.1 Gen 1 Port
- 9. Standard Security Lock Slot (Lock sold separately)
- 10. Power Button

### **Overview**



#### Right

- 1. Power Connector
- 2. USB Type-C<sup>™</sup> 3.1 Gen 1 Port
- 3. Ethernet Port (RJ-45)
- 4. HDMI Port (Cable not included)

- 5. USB 3.1 Gen 1 Port
- 6. Headphone/Microphone Combo Jack
- 7. HP Fingerprint Sensor



#### Overview

#### At a Glance

- Preinstalled with Windows 10 versions or FreeDOS 3.0
- Choice of 8th Generation Intel® Core™ i7, i5, i3 processors
- Display include your choice of 33.8 cm (13.3") diagonal HD, Ultra Wide Viewing Angle FHD, Touch or Non-Touch screen
- Integrated Intel® HD Graphics 610 and intel® UHD 620
- Enhanced security features including TPM2.0, HP BIOSphere, Hardware enforced Firmware Protection, HP Fingerprint Sensor and optional IR camera
- Passed 19 items of MIL-STD 810G testing plus an additional 120,000 hours of reliability testing through HP's Total Test Process<sup>1</sup>
- Weight starting at 3.28 lbs (1.49 kgs)
- HP Long-Life Rechargeable battery, with HP Fast Charge Technology recharges 50% in 30 minutes<sup>2</sup>
- Supports wireless LAN and wireless WWAN options for connectivity on the go
- Up to 512 GB Solid State Drives or 1 TB Hard Drive
- Up to 32 GB total system memory
- 720p HD webcam, IR camera for face authentication with Windows Hello
- Spill-resistant and optional backlit Keyboard with numeric keypad, and Clickpad with multi-touch gestures enabled, taps enabled as default
- Enjoy the rich conferencing experience of the Skype for Business™ Certified HP ProBook 430
  - MIL STD 810G testing is not intended to demonstrate fitness for U.S. Department of Defense contract requirements
    or for military use. Test results are not a guarantee of future performance under these test conditions. Damage
    under the MIL STD test conditions or any accidental damage requires an optional HP Accidental Damage Protection
    Care Pack.
  - 2. Recharges the battery up to 50% within 30 minutes when the system is off or in standby mode when used with the power adapter provided with the notebook. After charging has reached 50% capacity, charging speed will return to normal. Charging time may vary +/-10% due to System tolerance.

**NOTE:** See important legal disclosures for all listed specs in their respective features sections.



### **Technical Specifications**

#### **PRODUCT NAMES**

HP ProBook 430 G6 Notebook PC

#### OPERATING SYSTEMS

Preinstalled Windows 10 Pro 64<sup>1</sup>

Windows 10 Pro 64 (National Academic only)<sup>2</sup>

Windows 10 Home 641

Windows 10 Home Single Language 64<sup>1</sup> Windows 10 China Government Edition

FreeDOS 3.0

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

#### **PROCESSORS**

Intel® Core™ i7-8565U with Intel® UHD Graphics 620 (1.8 GHz base frequency, up to 4.6 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores)<sup>3,4,5,6</sup>

Intel® Core™ i5-8265U with Intel® UHD Graphics 620 (1.6 GHz base frequency, up to 3.9 GHz with Intel® Turbo Boost Technology, 6 MB L3 cache, 4 cores)<sup>3,4,5,6</sup>

Intel® Core™ i5-8365U vPro™ processor with Intel® UHD Graphics 620 (1.6 GHz base frequency, up to 4.1 GHz with Intel® Turbo Boost Technology, 6 MB L3 cache, 4 cores)<sup>3,4,5,6</sup>

Intel® Core™ i3-8145U with Intel® UHD Graphics 620 (2.1 GHz base frequency, up to 3.9 GHz with Intel® Turbo Boost Technology, 4 MB L3 cache, 2 cores)<sup>3,4,5,6</sup>

Intel® Core™ i7+ 8565U processor (Core™ i7 and 16 GB Intel® Optane™ memory) with Intel® UHD Graphics 620 (1.8 GHz base frequency, up to 4.6 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores)<sup>3,4,5,6,7</sup>

Intel® Core™ i5+ 8265U processor (Core™ i5 and 16 GB Intel® Optane™ memory) with Intel® UHD Graphics 620 (1.6 GHz base frequency, up to 3.9 GHz with Intel® Turbo Boost Technology, 6 MB L3 cache, 4 cores)<sup>3,4,5,6,7</sup>

Intel® Celeron® 4205U processor with Intel® HD Graphics 610 (1.8 GHz base frequency, 2 MB L3 cache, 2 cores)<sup>3,4,5,6</sup> Intel® Pentium® 5405U processor with Intel® HD Graphics 610 (2.3 GHz base frequency, 2 MB L3 cache, 2 cores)<sup>3,4,5,6</sup>

#### **Processors Family**

8th Generation Intel® Core™ i7 processor (i7-8565U)<sup>6</sup>
8th Generation Intel® Core™ i5 processor (i5-8265U, 8365U)<sup>6</sup>
8th Generation Intel® Core™ i3 processor (i3-8145U)<sup>6</sup>
Intel® Pentium® processor (5405U)<sup>6</sup>
Intel® Celeron® processor (4205U)<sup>6</sup>

- 3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.
- 4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.



### **Technical Specifications**

- 5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See <a href="http://www.intel.com/technology/turboboost">http://www.intel.com/technology/turboboost</a> for more information.
- NOTE: In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating
  system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8
  or Windows 7 drivers on http://www.support.hp.com.
- 7. Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system and requires configuration with an optional Intel® Core™ i(5 or 7)+ processor.

#### **CHIPSET**

Integrated with processor

#### **GRAPHICS**

#### Integrated

Intel® UHD graphics 6208

8. HD content required to view HD images.

#### DISPLAYS

#### Internal

#### Non-Touch

33.8 cm (13.3") diagonal HD SVA eDP anti-glare LED-backlit Ultraslim, 220 cd/m $^2$ , 67% sRGB for two WLAN antennas (1366 x 768) $^{8,10}$ 

33.8 cm (13.3") diagonal HD SVA eDP anti-glare LED-backlit Ultraslim, 220 cd/m $^2$ , 67% sRGB for HD camera and two WLAN antennas (1366 x 768) $^{8,10}$ 

33.8 cm (13.3") diagonal HD SVA eDP anti-glare LED-backlit Ultraslim, 220 cd/m², 67% sRGB for HD+IR camera and two WLAN antennas (1366 x 768)<sup>8,10</sup>

33.8 cm (13.3") diagonal HD SVA eDP anti-glare LED-backlit Ultraslim, 220 cd/m $^2$ , 67% sRGB for HD camera, WWAN and two WLAN antennas (1366 x 768) $^{8,10}$ 

33.8 cm (13.3") diagonal FHD UWVA eDP anti-glare LED-backlit slim, 220 cd/m $^2$ , 67% sRGB for HD camera and two WLAN antennas (1920 x 1080) $^{8,10}$ 

33.8 cm (13.3") diagonal FHD UWVA eDP anti-glare LED-backlit slim, 220 cd/m $^2$ , 67% sRGB for HD+IR camera and two WLAN antennas (1920 x 1080) $^{8,10}$ 

33.8 cm (13.3") diagonal FHD UWVA eDP anti-glare LED-backlit slim, 220 cd/m $^2$ , 67% sRGB for HD camera, WWAN and two WLAN antennas (1920 x 1080) $^{8,10}$ 

#### **Touch**

33.8 cm (13.3") diagonal HD SVA eDP LED-backlit Ultraslim touch screen, 220 cd/m², 67% sRGB for HD camera and two WLAN antennas (1366 x 768)<sup>8,9,10</sup>

33.8 cm (13.3") diagonal FHD UWVA eDP LED-backlit slim touch screen, 220 cd/m $^2$ , 67% sRGB for HD camera and two WLAN antennas (1920 x 1080) $^{8,9,10}$ 

33.8 cm (13.3") diagonal FHD UWVA eDP LED-backlit slim touch screen, 220 cd/m $^2$ , 67% sRGB for HD camera, WWAN and two WLAN antennas (1920 x 1080) $^{8,9,10}$ 

#### HDMI

Supports resolutions up to 4K 30Hz

8. HD content required to view HD images.



### **Technical Specifications**

- 9. Sold separately or as an optional feature.
- 10. Resolutions are dependent upon monitor capability, and resolution and color depth settings.

Docking station model	Total number of supported displays (incl. the notebook display)	Max. resolutions supported	Dock Connectors	Technical limitations
HP Thunderbolt Dock 120W G2	3	Dual 4k @60Hz	2xDP, 1xVGA, 1xTB, 1xUSB-C alt- mode	Dual 4k only with one display in to DP and + TB port or USB-C alt mode + TB port
HP USB-C Dock G4	3	Dual 2K @ 60Hz Single 4K @ 60Hz (3840 x 1440)	1xHDMI, 2xDP	
HP USB-C Universal Dock	3	Dual 4K @ 60Hz Single 5K @ 60Hz	2xDP	
HP USB-C Travel Dock	2	Single 2K @ 60Hz	1xHDMI, 1xVGA	Single external display Only HDMI or VGA at the time
HP USB-C Mini Dock	2	Single 4K @ 30Hz	1xHDMI, 1xVGA	Single external display Only HDMI or VGA at the time

#### STORAGE AND DRIVES

#### **Primary Storage**

500 GB 7200 rpm SATA<sup>11</sup> 1 TB 5400 rpm SATA<sup>11</sup>

#### Primary M.2 Storage

128 GB M.2 SATA TLC Solid State Drive<sup>11</sup>
256 GB PCIe® NVMe™ M.2 Value Solid State Drive<sup>11</sup>
512 GB PCIe® NVMe™ M.2 TLC Solid State Drive<sup>11</sup>
512 GB PCIe® NVMe™ M.2 Value Solid State Drive<sup>11</sup>

11. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

NOTE: PCIe SSD not available for Celeron

#### **MEMORY**

#### Memory

32 GB DDR4-2400 SDRAM (2 x 16 GB)<sup>12</sup>
16 GB DDR4-2400 SDRAM (1 x 16 GB)
16 GB DDR4-2400 SDRAM (2 x 8 GB)<sup>12</sup>
12 GB DDR4- 2400 SDRAM (4 GB and 8 GB (1 x 8 GB)<sup>12</sup>



### **Technical Specifications**

8 GB DDR4-2400 SDRAM (1 x 8 GB) 8 GB DDR4-2400 SDRAM (2 x 4 GB)<sup>12</sup> 4 GB DDR4-2400 SDRAM (1 x 4 GB)

#### Maximum

32 GB DDR4-2400 SDRAM12

#### **Memory Slots**

2 SODIMM
Both slots are customer accessible / upgradeable
DDR4 PC4 SODIMMS, system runs at 2400
Supports Dual Channel Memory

12. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

#### **NETWORKING/COMMUNICATIONS**

#### Wireless LAN (WLAN)

Realtek 802.11ac (2x2) WLAN and Bluetooth® 4.2 Combo<sup>13</sup> Intel® Dual Band Wireless-AC 9560 802.11ac (2x2) WLAN and Bluetooth® 5.0 Combo, non-vPro™<sup>13</sup>

#### **Broadband Wireless (WWAN)**

Intel® XMM™ 7262 LTE-Advanced (Cat6)<sup>14</sup> Intel® XMM™ 7360 LTE-Advanced (Cat9)<sup>14</sup>

#### **Ethernet**

Realtek RTL8111HSH-CG 10/100/1000 GbE NIC<sup>15</sup>

- 13. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.
- 14. WWAN module is optional, must be configured at the factory and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.
- 15. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

#### **AUDIO/MULTIMEDIA**



### **Technical Specifications**

#### Audio

Integrated microphone (Mono or Dual Array)
2 Integrated stereo speakers

#### Speaker Power

2W/4ohm Per speaker

#### Camera

720p HD camera<sup>8</sup>
720p HD camera+IR Camera<sup>8,9</sup>

- 8. HD content required to view HD images.
- 9. Sold separately or as an optional feature.

#### **KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS**

#### Keyboard

HP Premium Keyboard, spill resistant with optional backlit function

#### **Pointing Device**

Clickpad with multi-touch gesture support

#### **Function Keys**

ESC: system information

F1 - Display Switching

F2 - Blank

F3 - Brightness Down

F4 - Brightness Up

F5 - Audio Mute

F6 - Volume Down

F7 - Volume Up

F8 - Mic Mute

F9 - Blank or Backlit Toggle

F10 - numlk

F11 - Wireless

F12 – Sleep

#### **Hidden Functions**

Fn+R - Break

Fn+S - Sys Rq

Fn+C - Scroll Lock

#### **SOFTWARE AND SECURITY**

#### **BIOS**

HP BIOSphere Gen416

HP DriveLock & Automatic DriveLock

**BIOS Update via Network** 

Secure Erase<sup>17</sup>

Absolute Persistence Module<sup>18</sup>

**Pre-boot Authentication** 

**HP** Wireless Wakeup



### **Technical Specifications**

#### Software

HP Native Miracast Support<sup>19</sup>

**HP LAN-Wireless Protection** 

**HP Connection Optimizer** 

**HP 3D DriveGuard** 

**HP Hotkey Support - CMIT** 

**HP Jumpstart** 

HP Support Assistant<sup>20</sup>

**HP Noise Cancellation Software** 

**HP Host Based MAC Address Manager** 

Buy Office (sold separately)

#### **Manageability Features**

HP Driver Packs<sup>21</sup>

**HP System Software Manager (SSM)** 

**HP BIOS Config Utility (BCU)** 

**HP Client Catalog** 

HP Manageability Integration Kit Gen2<sup>22</sup>

Ivanti Management Suite<sup>23</sup>

HP Cloud Recovery<sup>24</sup>

#### **Client Security Software**

HP Client Security Suite Gen4<sup>25</sup> including:

HP Security Manager<sup>26</sup> (including Credential Manager, HP Password Manager, HP Spare Key)

HP Device Access Manager<sup>27</sup>

**HP Power On Authentication** 

Windows Defender<sup>28</sup>

**HP Fingerprint Sensor** 

#### **Security Management**

Secure Erase<sup>17</sup>

TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified)<sup>29</sup>

SATA 0,1 port disablement (viaBIOS)

RAID configurations<sup>30</sup>

Serial, USB enable/disable (viaBIOS)

Power-on password (viaBIOS)

Setup password (viaBIOS)

Support for chassis padlocks and cable lock devices

Integrated hood sensor

HP Sure Click<sup>31</sup>



### **Technical Specifications**

- 16. HP BIOSphere Gen4 requires Intel(R) or AMD 8th Gen processors. Features may vary depending on the platform and configurations.
- 17. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method.
- 18. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: <a href="http://www.absolute.com/company/legal/agreements/">http://www.absolute.com/company/legal/agreements/</a> computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement

and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

- 19. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming
- 20. HP Support Assistant requires Windows and Internet access.
- 21. HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.
- 22. HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html
- 23. Ivanti Management Suite subscription required
- 24. HP Cloud Recovery is available for HP Elite and Pro desktops and laptops PCs with Intel® or AMD processors and requires an open, wired network connection. Note: You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Detail please refer to: https://support.hp.com/us-en/document/c05115630
- 25. HP Client Security Suite Gen 4 requires Windows and Intel® or AMD 8th generation processors.
- 26. HP Password Manager requires Internet Explorer or Chrome or FireFox. Some websites and applications may not be supported. User may need to enable or allow the add-on / extension in the internet browser.
- 27. HP Device Access Manager requires HP Client Security Suite Gen4.
- 28. Windows Defender Opt in and internet connection required for updates.
- 29. Firmware TPM is version 2.0. Hardware TPM is v1.2, which is a subset of the TPM 2.0 specification version v0.89 as implemented by Intel Platform Trust Technology (PTT).
- 30. RAID configuration is optional and does require a second hard drive.
- 31. HP Sure Click is available on most HP PCs and supports Microsoft® Internet Explorer and Chromium™. Supported attachments include Microsoft Office (Word, Excel, PowerPoint) and PDF files in read only mode, when Microsoft Office or Adobe Acrobat are installed.

#### **POWER**

HP Smart 65 W External AC power adapter<sup>32</sup>
HP Smart 65 W EM External AC power adapter<sup>32</sup>
HP Smart 65 W USB Type-C™ adapter<sup>32</sup>
HP Smart 45 W External AC power adapter<sup>32</sup>
HP Smart 45 W USB Type-C™ adapter<sup>32</sup>

#### **Primary Battery**

HP Long Life 3-cell, 45 Wh Li-ion<sup>33</sup>

#### **Power Cord**

3-wire plug - 1m<sup>32</sup>
3-wire plug - 1.8m<sup>32</sup>
2-wire plug - 1m<sup>32</sup>
Duckhead power cord- 1m<sup>32</sup>
Duckhead power cord- 1.8m<sup>32</sup>



### **Technical Specifications**

#### **Battery Life**

Up to 14 hours 34

#### **Battery Weight**

0.49 lb 0.22 kg

- 32. Availability may vary by country.
- 33. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 34. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See <a href="http://www.bapco.com">http://www.bapco.com</a> for additional details.

#### **WEIGHTS & DIMENSIONS**

#### Weight

Starting at 3.28 lb<sup>35</sup> Starting at 1.49 kg<sup>35</sup>

#### Dimensions (w x d x h)

12.15 x 9.09 x 0.71 in 30.85 x 23.1 x 1.8 cm

35. Weight will vary by configuration.

#### **PORTS/SLOTS**

#### **Ports**

1 USB 3.1 Type-C™ Gen 1 (Power delivery, DisplayPort™ 1.2)

1 USB 3.1 Gen 1

1 USB 3.1 (Powered port)

1 HDMI 1.4b36

1 RJ-45

1 AC power

1 Headphone/microphone combo jack

#### **Expansion Slots**

1 SD

Supports SD, SDHC, SDXC

36. HDMI cable sold separately.

#### SERVICE AND SUPPORT



#### HP ProBook 430 G6 Notebook PC

## QuickSpecs

### **Technical Specifications**

HP Services offers 3-year and 1-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for Long Life Batteries which will have same 1-year or 3-year limited warranty as the platform. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.<sup>37</sup>

37. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit <a href="http://www.hp.com/go/cpc">http://www.hp.com/go/cpc</a>. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



## **Technical Specifications**

### **ENVIRONMENTAL & INDUSTRY**

**НР Р**повоок 430 G6 **N**отевоок **P**C

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:  •IT ECO declaration				
•EPEAT® Silver registered in the United States. See http://www.epeat.net for registration status in				
your country. •TCO or TCO Certified Edge				
		100VAC, 60Hz		
		5.14 W		
2.84 W	2.79 W	2.77 W		
0.61 W	0.64 W	0.61 W		
0.38 W	0.42 W	0.38 W		
family. HP computers marked with the ENERGY STAR® Logo are compliant with the ap Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. family does not offer ENERGY STAR® compliant configurations, then energy efficiency for a typically configured PC featuring a hard disk drive, a high efficiency power suppl Microsoft Windows® operating system.				
		100VAC, 60Hz		
18 BTU/hr	18 BTU/hr	18 BTU/hr		
10 BTU/hr	10 BTU/hr	9 BTU/hr		
2 BTU/hr	2 BTU/hr	2 BTU/hr		
1 BTU/hr	1 BTU/hr	-		
Heat dissipation is calculated base for one hour.	ed on the measured watts, a	assuming the service level is attained		
Sound Power		Sound Pressure		
(L <sub>WAd</sub> , bels)		(L <sub>pAm</sub> , decibels)		
2.7		24.2		
2.8 25.1				
features and/or components cont • 3 USB ports • 1 PC card slot (type I/II) • 1 ExpressCard/54 slot • 1 IEEE 1394 Port • 2 SODIMM memory slots	ained in the product may in			
	be labeled with one or more of the •IT ECO declaration •US ENERGY STAR® •EPEAT® Silver registered in the U your country. •TCO or TCO Certified Edge The configuration used for the End Notebook model is based on a Typ   115VAC, 60Hz  5.17 W  2.84 W  0.61 W  0.38 W  Energy efficiency data listed is for family. HP computers marked witl Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu Microsoft Windows® operating sys  115VAC, 60Hz  18 BTU/hr  10 BTU/hr  10 BTU/hr  1 BTU/hr  Heat dissipation is calculated base for one hour.  Sound Power (LwAd, bels)  2.7  2.8  This product can be upgraded, pos features and/or components cont • 3 USB ports • 1 PC card slot (type I/II) • 1 ExpressCard/54 slot • 1 IEEE 1394 Port • 2 SODIMM memory slots • Optional expansion base docking • 1 multi-bay II storage port	be labeled with one or more of these marks:  IT ECO declaration  US ENERGY STAR®  EPEAT® Silver registered in the United States. See http://ww.your country.  ICO or TCO Certified Edge  The configuration used for the Energy Consumption and Decl Notebook model is based on a Typically Configured Notebook  115VAC, 60Hz  230VAC, 50Hz  5.17 W  5.30 W  2.84 W  2.79 W  0.61 W  0.64 W  0.38 W  0.42 W  Energy efficiency data listed is for an ENERGY STAR® complia family. HP computers marked with the ENERGY STAR® Logo a Environmental Protection Agency (EPA) ENERGY STAR® specifamily does not offer ENERGY STAR® compliant configuration for a typically configured PC featuring a hard disk drive, a hig Microsoft Windows® operating system.  115VAC, 60Hz  230VAC, 50Hz  18 BTU/hr  10 BTU/hr  11 BTU/hr  12 BTU/hr  13 BTU/hr  14 BTU/hr  15 BTU/hr  16 BTU/hr  17 BTU/hr  18 BTU/hr  19 BTU/hr  10 BTU/hr  10 BTU/hr  11 BTU/hr  11 BTU/hr  12 BTU/hr  13 BTU/hr  14 BTU/hr  15 BTU/hr  16 BTU/hr  17 BTU/hr  18 BTU/hr  19 BTU/hr  10 BTU/hr  10 BTU/hr  11 BTU/hr  11 BTU/hr  12 BTU/hr  13 BTU/hr  14 BTU/hr  15 BTU/hr  16 BTU/hr  17 BTU/hr  18 BTU/hr  19 BTU/hr  10 BTU/hr  10 BTU/hr  10 BTU/hr  10 BTU/hr  11 BTU/hr  12 BTU/hr  13 BTU/hr  14 BTU/hr  15 BTU/hr  16 BTU/hr  17 BTU/hr  18 BTU/hr  18 BTU/hr  19 BTU/hr  10 BTU/hr		



## **Technical Specifications**

	Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.					
Batteries	This battery(	This battery(s) in this product comply with EU Directive 2006/66/EC				
	Batteries use	d in the product do not contain:				
		ter the1ppm by weight				
	Cadmium greater than 20ppm by weight					
	Rattery cize:	CR2032 (coin cell)				
	_	lithium/manganese dioxide				
Additional Information	•	t is in compliance with the Restrictions of Hazardous Subs	stances (RoHS) directive -			
	2011/65/EC.	donation designs data assume to other table at a Plantaine to a de-				
	• This HP pro Directive – 20	duct is designed to comply with the Waste Electrical and E	electronic Equipment (WEEE)			
	California; Safe Drinking					
		xic Enforcement Act of 1986).	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,			
	• This product is in compliance with the IEEE 1680.1 (EPEAT) standard at the <silver> level in the</silver>					
		//www.epeat.net for registration status by country. Sear	, ,			
	HP's 3rd party option store for solar generator accessories at http://www.hp.com/go/options					
	<ul> <li>Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO10</li> <li>This product contains 0% post-consumer recycled plastic (by wt.)</li> <li>This product is 95.1% recycle-able when properly disposed of at end of life.</li> </ul>					
Packaging Materials	External:	PAPER/Corrugated	281 g			
	Internal:	PLASTIC/Polyethylene Expanded - EPE	62 g			
		PLASTIC/Polyethylene low density – LDPE	9 q			
Material Usage	This product	does not contain any of the following substances in exces				
<b>-</b>	to the HP General Specification for the Environment at					
	http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):					
	<ul> <li>Asbestos</li> <li>Certain Azo Colorants</li> <li>Certain Brominated Flame Retardants – may not be used as flame retardants in plastics</li> <li>Cadmium</li> <li>Chlorinated Hydrocarbons</li> </ul>					
	Chlorinated Hydrocarbons  Chlorinated Paraffins  Formaldehyde  Halogenated Diphenyl Methanes  Lead carbonates and sulfates					
	Lead and Lead compounds					
	<ul> <li>Mercuric Oxide Batteries</li> <li>Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user.</li> <li>Ozone Depleting Substances</li> </ul>					
	Polybrominated Biphenyls (PBBs)     Polybrominated Riphenyl Ethers (PBBs)					
	<ul><li>Polybrominated Biphenyl Ethers (PBBEs)</li><li>Polybrominated Biphenyl Oxides (PBBOs)</li></ul>					
		ated Biphenyl (PCB)				
		ated Terphenyls (PCT)				
	tail packaging has been					
voluntarily removed from most applications.						
	Radioactive Substances					
• Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)						



### **Technical Specifications**

Packaging Usage	HP follows these guidelines to decrease the environmental impact of product packaging:  • Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.  • Eliminate the use of ozone-depleting substances (ODS) in packaging materials.  • Design packaging materials for ease of disassembly.  • Maximize the use of post-consumer recycled content materials in packaging materials.  • Use readily recyclable packaging materials such as paper and corrugated materials.  • Reduce size and weight of packages to improve transportation fuel efficiency.  • Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management and Recycling	HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <a href="http://www.hp.com/go/reuse-recycle">http://www.hp.com/go/reuse-recycle</a> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.  The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <a href="http://www.hp.com/go/recyclers">http://www.hp.com/go/recyclers</a> . These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM
HP Inc. Corporate Environmental Information	customers who integrate and re-sell HP equipment.  For more information about HP's commitment to the environment:  Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_ISO_14K _Certificate.pdf and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

#### **SYSTEM UNIT**

### Stand-Alone Power Requirements (AC

Power)

Nominal Operating Voltage 19V
Average Operating Power Win 10
Integrated graphics 5.71W
Max Operating Power UMA < 45W

**Temperature** 

Operating 32° to 95° F (0° to 35° C) Non-operating -4° to 140° F (-20° to 60° C)

**Relative Humidity** 

Operating 10% to 90%, non-condensing

5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

Non-operating

Shock



### **Technical Specifications**

Operating 40 G, 2 ms, half-sine 200 G, 2 ms, half-sine Non-operating

**Random Vibration** 

Operating 0.75 grms 1.50 grms Non-operating

**Altitude (unpressurized)** 

Operating -50 to 10,000 ft (-15.24 to 3,048 m) -50 to 40,000 ft (-15.24 to 12,192 m) Non-operating

**Planned Industry Standard** 

**Certifications** 

UL Yes CSA Yes **FCC Compliance** Yes

**ENERGY STAR®** Selected models<sup>38</sup> **EPEAT® 2019** Yes, Silver in U.S.39

**ICES** Yes Australia / Yes **NZ A-Tick Compliance** Yes CCC Yes Japan VCCI Compliance Yes KC Yes **BSMI** Yes **CE Marking Compliance** Yes **BNCI or BELUS** Yes CIT Yes **GOST** Yes Saudi Arabian Compliance (ICCP) Yes **SABS** Yes **UKRSERTCOMPUTER** 

38. Configurations of the HP ProBook 430 G6 that are ENERGY STAR® certified2 are identified as HP ProBook 430 G6 ENERGY STAR on HP websites and on http://www.energystar.gov.

Yes

39. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit http://www.epeat.net for more information.



### **Technical Specifications**

#### **DISPLAYS**

**Note:** All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Panel LCD 14 inch diagonal FHD (1920 x 1080) Anti-Glare WLED UWVA 45% NTSC 250 nits eDP slim 

 Outline Dimensions (W x H x D)
 316.17 x 197.98 (max)

 Active Area
 309.37 x 174.02 (typ.)

Weight 285 g (max)

Diagonal Size 14.0 inch

Thickness 3.0 mm (max)

Interface eDP 1.2 (2 lane)

Surface Treatment Anti-glare

Touch Enabled No

Contrast Ratio600:1 (typ)Refresh Rate60 HzBrightness250 nits

Pixel Resolution 1920 x 1080 (FHD)

Format of LCD Pixel Arrangement RGB Backlight LED

**Color Gamut Coverage** 45% of NTSC

**Color Depth** 6 bits

Viewing Angle UWVA 85/85/85

Panel LCD 13.3 inch diagonal FHD (1920 x 1080) Anti-Glare WLED UWVA 45% NTSC 220nits eDP slim NB non-touch 

 Outline Dimensions (W x H x D)
 300.56 x 187.77 max.

 Active Area
 293.76 x 165.24 typ.

Weight <260 max.
Diagonal Size 13.3"

Thickness 3.0 mm max.
Interface eDP 1.2 (2 lanes)
Surface Treatment Anti-glare

**Touch Enabled** No

Contrast Ratio 600:1 (typ)
Refresh Rate 60 Hz

**Brightness** 220 nits typical (Panel Only)

Pixel Resolution 1920 x 1080 (FHD)

Format of LCD Pixel Arrangement RGB Backlight LED

**Color Gamut Coverage** 45% of NTSC

Color Depth 6 bits (Hi FRC @ system GFX output 8bits)

Viewing Angle UWVA 85/85/85

**Outline Dimensions (W x H x D)** 300.56 x 187.77 max.



### **Technical Specifications**

Panel LCD 13.3 inch diagonal FHD (1920 x 1080) WLED UWVA 45% NTSC 220nits eDP slim NB touch **Active Area** 293.76 x 165.24 typ.

Weight <383 max.

Diagonal Size 13.3"

Thickness3.2 mm max.InterfaceeDP 1.2 (2 lanes)Surface TreatmentBrightView Glass

**Touch Enabled** Yes

Contrast Ratio 600:1 (typ)
Refresh Rate 60 Hz

**Brightness** 220 nits typical (Panel Only)

Pixel Resolution 1920 x 1080 (FHD)

Format of LCD Pixel Arrangement RGB Backlight LED

Color Gamut Coverage 45% of NTSC

**Color Depth** 6 bits (Hi FRC @ system GFX output 8bits)

Viewing Angle UWVA 85/85/85

Panel LCD 13.3 inch diagonal HD (1366 x 768) Anti-Glare WLED SVA 45% NTSC 220nits eDP slim NB non-touch **Outline Dimensions (W x H x D)** 300.56 x 187.77 max. (w/ PCB & w/o bracket)

**Active Area** 293.83 x 165.20 typ.

Weight <260 max.

Diagonal Size 13.3 (inch)

Thickness 3.0 mm max.

Interface eDP 1.2 (2 lanes)

Surface Treatment Anti-qlare

Juliace Heatment Anti-gland

**Touch Enabled** No

Contrast Ratio 300:1 (typ)
Refresh Rate 60 Hz

**Brightness** 220 nits typical (Panel Only)

Pixel Resolution 1366 x 768 (HD)

Format of LCD Pixel Arrangement RGB Backlight LED

Color Gamut Coverage 45% of NTSC

**Color Depth** 6 bits (Hi FRC @ system GFX output 8bits)

Viewing Angle SVA 45/45/15/30

Panel LCD 13.3 inch diagonal HD (1366 x 768) WLED SVA 45% NTSC 220nits eDP slim NB touch **Outline Dimensions (W x H x D)** 300.56 x 187.77 max. (w/ PCB & w/o bracket)

**Active Area** 293.83 x 165.20 typ.

Weight <383 max.

Diagonal Size 13.3 (inch)

Thickness 3.2 mm max.

Interface eDP 1.2 (2 lanes)



### **Technical Specifications**

Surface Treatment BrightView Glass

**Touch Enabled** Yes

Contrast Ratio 300:1 (typ)
Refresh Rate 60 Hz

**Brightness** 220 nits typical (Panel Only)

Pixel Resolution 1366 x 768 (HD)

Format of LCD Pixel Arrangement RGB Backlight LED

**Color Gamut Coverage** 45% of NTSC

**Color Depth** 6 bits (Hi FRC @ system GFX output 8bits)

Viewing Angle SVA 45/45/15/30

# STORAGE AND DRIVES Hard Drives

500 GB 7200 rpm SATA Hard Drive **Drive Weight** 0.20 lbs (92 g) ~ 0.21 lbs (95 g)

Rotation speed 7200 rpm

Cache Buffer Up to 32 MB

Height 0.28 in (7 mm)

Width 2.75 in (69.85 mm)

Interface ATA-8, SATA 3.0

Transfer Rate 600 MB/s

**Seek Time** Single Track: 2 ~ 1.5 ms;

Average: 11 ~ 13 ms; Maximum: 18 ~ 22 ms

**Logical Blocks** 976,773,168

**Operating Temperature** 32° to 140° F (0° to 60° C) [top cover temp]

Security Features ATA Security

Features S.M.A.R.T., NCQ, Ultra DMA

1 TB 5400 rpm SATA Hard Drive Drive Weight 0.21 lbs (94 g)

Rotation speed 5400 rpm

Cache Buffer Up to 32 MB

Height 0.28 in (7.2 mm)

Width 2.75 in (69.85 mm)

Interface ATA-8, SATA 3.0

**Transfer Rate** 600 MB/s

Seek Time Single Track2 ms

Average12 ~ 13 ms Maximum18 ~ 22 ms

**Logical Blocks** 1,953,525,168

**Operating Temperature** 32° to 140° F (0° to 60° C) [top cover temp]



### **Technical Specifications**

Security Features ATA Security

Features S.M.A.R.T., NCQ, Ultra DMA

SSD 128 GB 2280 M2 SATA-3 TLC Form Factor M.2 2280
Capacity 128GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 ATA-8, SATA 3.0

 Maximum Sequential Read
 Up To 520 MB/s

 Maximum Sequential Write
 Up To 450 MB/s

 Logical Blocks
 250,069,680

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features DIPM; TRIM; DEVSLP

256 GB 2280 PCIe NVMe Value Solid State Drive Form Factor M.2 2280
Capacity 256 GB
NAND Type TLC

Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3Maximum Sequential ReadUp To 1700 MB/sMaximum Sequential WriteUp to 1300 MB/sLogical Blocks500,118,192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM; L1.2

512 GB 2280 M2 PCIe NVMe Form Factor TLC Solid State Drive Capacity

Form Factor M.2 2280
Capacity 512 GB
NAND Type TLC

Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Interface PCIe NVMe Gen3X4
Maximum Sequential Read Up To 2600 MB/s
Maximum Sequential Write Up To 1400 MB/s
Logical Blocks 1,000,215,216

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]



Not all configuration components are available in all regions/countries. c06142919 — DA 16310 - Worldwide — Version 15 — October 11, 2019

### **Technical Specifications**

Features TRIM; L1.2

16 GB 2280 PCIe-3x2 NVMe Form Factor 3D Xpoint Solid State Drive Capacity

Form Factor M.2 2280
Capacity 16 GB
NAND Type Xpoint

Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3X2

Maximum Sequential Read 1400 Maximum Sequential Write 300

Logical Blocks 28,181,188

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features L1.2

512 GB 2280 PCIe NVMe Value Solid State Drive Form Factor M.2 2280
Capacity 512 GB
NAND Type Value

Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3X4Maximum Sequential ReadUp To 1500 ~ 1700 MB/sMaximum Sequential WriteUp To 860 ~ 1500MB/s

**Logical Blocks** 1,000,215,216

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** ATA Security, TRIM; L1.2

### **NETWORKING/COMMUNICATIONS**

#### **WWAN**

Intel® XMM™ 7262 LTE- Technology/Operating
Advanced DL CAT6¹ bands

FDD LTE: 2100 (Band 1), 1800 (Band 3), 850 (Band 5), 2600 (Band 7), 900

(Band 8), 800 (Band 20), 700 (Band 28),

HSPA+: 2100 (Band 1), 850 (Band 5), 900 (Band 8)

Wireless protocol standards

3GPP Release 11 LTE Specification CAT.6, DL 40MHz BW throughput up to

300Mbps; UL 20MHz throughput up to 50Mbps

WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification

**GPS** Standalone, A-GPS (MS-A, MS-B and XTRA)

**GPS bands** 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz

Maximum data rates LTE: 300 Mbps (Download), 50 Mbps (Upload)

DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)

Maximum output power LTE: 23 dBm

HSPA+: 23.5 dBm



### **Technical Specifications**

LTE: 1,200 mA (peak); 830 mA (average) Maximum power consumption HSPA+: 1,100 mA (peak); 680 mA (average)

**Form Factor** M.2, 3042-S3 Key B

Weiaht 6 q

**Dimensions** 42 x 30 x 2.3 mm

(Length x Width x Thickness)

> 1. WWAN module is optional, must be configured at the factory and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

Intel® XMM™ 7360 LTE-Advanced CAT9<sup>1</sup>

Technology/Operating

bands

FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3),

1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 1400 (Band 11), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1400 (Band 21), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30),

1700/2100 (Band 66).

TDD LTE: 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41).

HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4).

850 (Band 5), 900 (Band 8) MHz

Wireless protocol

standards

3GPP Release 11 LTE Specification CAT.9, DL 60MHz BW throughput up to

450Mbps; UL 20MHz throughput up to 50Mbps

WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification

**GPS** Standalone, A-GPS (MS-A, MS-B)

**GPS** bands 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz

Maximum data rates LTE: 450 Mbps (Download), 50 Mbps (Upload)

> DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)

Maximum output power LTE: 23 dBm

HSPA+: 23.5 dBm

Maximum power consumption

LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)

**Form Factor** M.2, 3042-S3 Kev B

Weight 5.8 q

**Dimensions** 

42 30 x 2.3 mm

(Length x Width x Thickness)

> 1. WWAN module is optional, must be configured at the factory and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

WLAN

Intel® 9560 Wireless LAN Standards IEEE 802.11a

IEEE 802.11b 802.11a/b/g/n/ac (2x2) IEEE 802.11q

IEEE 802.11n



### **Technical Specifications**

WLAN and Bluetooth® 5.0

Combo¹ non-vPro

IEEE 802.11d

IEEE 802.11e

IEEE 802.11h

IEEE 802.11i

IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11r

InteroperabilityWi-Fi® certifiedFrequency Band802.11b/g/n

• 2.402 - 2.482 GHz

802.11a/n/ac

4.9 – 4.95 GHz (Japan)
5.15 – 5.25 GHz
5.25 – 5.35 GHz

5.47 – 5.725 GHz
5.825 – 5.850 GHz

**Data Rates** • 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, , 80MHz &

160MHz)

**Modulation** Direct Seguence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security<sup>3</sup>
• IEEE and WiFi® compliant 64 / 128 bit WEP encryption for a/b/q

mode only

• AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

• IEEE 802.11i

Cisco Certified Extensions, all versions through CCX4 and CCX Lite

WAPI

Network Architecture /

Models Roaming Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

IEEE 802.11 compliant roaming between access points

Output Power<sup>2</sup> • 802.11b: +18.5dBm minimum

• 802.11g : +17.5dBm minimum • 802.11a : +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
802.11n HT40(2.4GHz): +14.5dBm minimum
802.11n HT20(5GHz): +15.5dBm minimum
802.11n HT40(5GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm minimum
802.11ac VHT160(5GHz): +11.5dBm minimum

Power Consumption Transmit mode: 2.0 W

Receive mode: 1.6 W



### **Technical Specifications**

Idle mode (PSP)180 mW (WLAN Associated)
Idle mode: 50 mW (WLAN unassociated)
Connected Standby/Modern Standby: 10mW

Radio disabled: 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity<sup>3</sup>** 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard with CNVi Interface

**Dimensions** 1. Type 2230: 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

**Weight** 1. Type 2230: 2.8g

2. Type 126: 1.3g

Operating Voltage 3.3v +/- 9%

**Temperature** Operating 14° to 158° F (–10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

**Humidity** Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

**Altitude** Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF: LED White – Radio ON

- 1. Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.
- 3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

#### HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0 Wireless Technology

**Bluetooth® Specification** 4.0/4.1/4.2/5.0 Compliant

Frequency Band 2402 to 2480 MHz

**Number of Available** Legacy: 0~79 (1 MHz/CH) **Channels** BLE: 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps signaling rate<sup>1</sup>

BLE: 1 Mbps signaling data rate<sup>1</sup>
1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)



### **Technical Specifications**

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

**Power Consumption** Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

**Electrical Interface** USB 2.0 compliant

**Bluetooth Software** 

Supported **Link Topology**  Microsoft Windows Bluetooth Software

**Power Management** 

**Certifications** 

FCC (47 CFR) Part 15C, Section 15.247 & 15.249 ETS 300 328. ETS 300 826

**Power Management** 

Certifications

Low Voltage Directive IEC950UL, CSA, and CE Mark

Microsoft Windows ACPI, and USB Bus Support

**Bluetooth Profiles** Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode

LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

Realtek

802.11a/b/q/n/ac (2x2) WLAN and Bluetooth® 4.2 Combo<sup>1</sup>

Wireless LAN Standards

IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac

Interoperability **Frequency Band**  Wi-Fi® certified 802.11b/a/n •2.402 - 2.482 GHz

802.11a/n

•4.9 – 4.95 GHz (Japan) •5.15 - 5.25 GHz •5.25 - 5.35 GHz •5.47 - 5.725 GHz

•5.825 - 5.850 GHz

**Data Rates** 

- 802.11b: 1, 2, 5.5, 11 Mbps
- 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
- 802.11ac: MCS0 ~ MCS7, (1SS) (20MHz, 40MHz, and 80MHz)



### **Technical Specifications**

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

IEEE 802.11i

Cisco Certified Extensions, all versions through CCX4 and CCX Lite

IEEE and WiFi® compliant 64 / 128 bit WEP encryption for a/b/a

WAPI

**Network Architecture** 

Models

Security<sup>3</sup>

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

**Output Power<sup>2</sup>** 

802.11b: +14dBm minimum

802.11a: +12dBm minimum

802.11a: +12dBm minimum

802.11n HT20(2.4GHz): +12dBm minimum

802.11n HT40(2.4GHz): +12dBm minimum 802.11n HT20(5GHz): +10dBm minimum

802.11n HT40(5GHz): +10dBm minimum

802.11ac VHT80(5GHz): +10dBm minimum

**Power Consumption** Transmit: 2.0 W (max)

Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated) Idle mode: 50 mW (WLAN unassociated) Connect Standby: 10 mW (WLAN+BT)

Radio disabled: 8 mW

ACPI and PCI Express compliant power management **Power Management** 

802.11 compliant power saving mode

Receiver Sensitivity<sup>3</sup> 802.11b, 1Mbps: -93.5dBm maximum

802.11b. 11Mbps: -84dBm maximum 802.11a/q, 6Mbps: -86dBm maximum 802.11a/q, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

High efficiency antenna with spatial diversity, mounted in the display Antenna type

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

**Form Factor** PCI-Express M.2 MiniCard

**Dimensions** Type 2230: 2.3 x 22.0 x 30.0 mm

Weight Type 2230: 2.8g **Operating Voltage** 3.3v +/- 9%

**Temperature** Operating 14° to 158° F (-10° to 70° C)

> Non-operating -40° to 176° F (-40° to 80° C)

**Humidity** Operating 10% to 90% (non-condensing)



### **Technical Specifications**

Non-operating 5% to 95% (non-condensing)

Altitude 0 to 10,000 ft (3,048 m) Operating

0 to 50,000 ft (15,240 m) Non-operating

**LED Activity** LED Amber - Radio OFF; LED White - Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

#### HP Integrated Module with Bluetooth 4.0/4.2 Wireless Technology

**Bluetooth® Specification** 4.0/4.2 Compliant **Frequency Band** 2402 to 2480 MHz

**Number of Available** Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH) Channels

**Signaling Data Rate** Legacy: 3 Mbps signaling data rate1

BLE: 1 Mbps signaling data rate1

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

**Power Consumption** Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

**Electrical Interface** USB 2.0 compliant

**Bluetooth Software** 

Supported **Link Topology**  Microsoft Windows Bluetooth Software

**Power Management** 

Microsoft Windows ACPI, and USB Bus Support FCC (47 CFR) Part 15C, Section 15.247 & 15.249

**Power Management** 

ETS 300 328, ETS 300 826

Certifications

Certifications

Low Voltage Directive IEC950UL, CSA, and CE Mark

**Bluetooth Profiles** 

BT4.1-ESR 5/6/7 Compliance

Supported LE Link Layer Ping

LE Dual Mode LE Link Laver

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full

LE Privacy 1.2 –Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)



### **HP ProBook 430 G6 Notebook PC**

# QuickSpecs

### **Technical Specifications**

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)



### **Technical Specifications**

#### **POWER**

HP 45W Smart AC Adapter **Dimensions (H x W x D)** 3.74 x 1.57 x 1.04 in (9.5 x 4.0 x 2.65 cm)

**Weight** 0.386 lb (175g) max

**Input** 90 to 265 VAC

**Input Efficiency** 87.74% at 115Vac and 88.4% at 230Vac

Input frequency range 47 to 63 Hz
Input AC current 1.4 A at 90 VAC

input ne current

Output Output power 45W

**DC output** 19.5V

**Hold-up time** 5 msec at 115 VAC input

Output current limit <8.0A

Connector 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords

**Environmental Design** Operating 32°F to 95°F (0° to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20° to 85°C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5,000 m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Certifications CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B.

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.

HP 65W Smart AC Adapter Dimensions 90x51x28.5mm

**Weight** unit: 220g +/- 10g

**Input Efficiency** 88% at 115 VAC and 89% at 230 VAC

Input frequency range 47 to 63 Hz
Input AC current 1.7 A at 90 VAC

Output Output power 65W

DC output 19.5V

**Hold-up time** 5 ms at 115 VAC input

Output current limit <11A

**Connector** 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords

**Environmental Design** Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)



### **Technical Specifications**

Humidity 20% to 95%

Storage Humidity 10% to 95%

**EMI and Safety** Certifications

CE Mark - full compliance with LVD and EMC directives\* Worldwide safety standards - IEC60950, EN60950, UL60950, Class 1, SELV: Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B. CISPR22 Class B, CCC, NOM-1 NYCE; MTBF - over 200,000 hours at 25°C

ambient condition.

**HP 65W EM Smart AC** adapter

Dimensions 102x55x30mm Weight 270a +/- 10a

> **Input Efficiency** 87% min at 115V/230V

Input frequency range 47 to 63 Hz

Input AC current 1.7 A at 90 VAC and maximum load

DC output 65W(19.5V/3.33A) Hold-up time 5 msec at 115 VAC input

<11A. Over voltage protection- 29V max **Output current limit** 

0° to 35° C

automatic shutdown

4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords Connector

**Environmental Design** temperature

Operating

Non-operating (storage) -20° to 85° C

temperature

Altitude 0 to 5,000 m **Humidity** 0% to 95% **Storage Humidity** 0% to 95%

**EMI and Safety** Certifications

CE Mark - full compliance with LVD and EMC directives\* Worldwide safety standards - IEC60950, EN60950, UL60950, Class 1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; MTBF - over 200,000 hours at 25°C

ambient condition.

AC Adapter 65 Watt nPFC Dimensions **USB** type C

Weight

74x74x28.5mm unit: 245q +/- 10q

**Input Efficiency** 81.5% min at 115 Vac/ 230Vac @ 5V/3A

86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 10V/5A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A

47 ~ 63 Hz Input frequency range

1.7 A at 90 VAC and maximum load Input AC current

**Output power** 65W



### **Technical Specifications**

DC output 5V/9V/10V/12V/15V/20V

Hold-up time 5ms at 115 Vac input

**Output current limit** <8.0A

Connector Type C

**Environmental Design Operating** 32°Fto 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

**Humidity** 5% to 95% **Storage Humidity** 5% to 95%

**EMI and Safety** Certifications

CE Mark - full compliance with LVD and EMC directives\* Worldwide safety standards - IEC60950, EN60950, UL60950, Class 1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B. CISPR22 Class B, CCC, NOM-1 NYCE; MTBF - over 200,000 hours at 25°C

ambient condition.

62.0x62.0x28.5mm

AC Adapter 45 Watt nPFC Dimensions **USB** type C

Weight unit: 220g +/- 10g

> **Input Efficiency** Average Efficiency of 25%, 50%, 75%, 100%

> > load condition with 115Vac/230Vac Spec:5V: 81.5%9V:86.7%10V:87.5%12V:87.8%15V:

87.8%20V:87.8%

Input frequency range 47 ~ 63Hz

**Input AC current** Max. 1.4 A at 90 Vac

**Output power** 5V/15W

> 9V/27W 10V/37.5W 12V/45W 15V/45W 20V/45W

DC output 5V / 9V / 10V /12V / 15V / 20V

Hold-up time 5ms at 115 Vac input

**Output current limit** <5.0A

Connector Type C

**Environmental Design** Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%



### **Technical Specifications**

EMI and Safety Certifications CE Mark - full compliance with LVD and EMC directives\* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; MTBF - over 200,000 hours at 25°C ambient condition.

3 Cell WHr 45 Long Life -Polymer HP Fast Charge Technology<sup>1</sup> **Dimensions** 6.0. x184.7x88.9 mm

Weight 0.22 kg (0.48lb)

Cells/Type 3cell Lithium-Ion

Voltage 11.55V Amp-hour capacity 3.900Ah Watt-hour capacity 45Wh

Operating (Charging) 32° to 113° F (0° to 45° C)
Operating (Discharging) 14° to 122° F (-10° to 60° C)

1. Recharges the battery up to 50% within 30 minutes when the system is off or in standby mode when used with the power adapter provided with the notebook. After charging has reached 50% capacity, charging speed will return to normal. Charging time may vary +/-10% due to System tolerance.

#### **Country of Origin**

China



## Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part Number
Cases	HP Essential Top Load Case	H2W17AA
	HP Essential Backpack	H1D24AA
	HP Essential Messenger Case	H1D25AA
Docking	HP USB-C Mini Dock	1PM64AA
	HP USB-C Universal Dock	1MK33AA
	HP USB-C Dock G4	3FF69AA
Input/Output	HP USB Essential Keyboard and Mouse	H6L29AA
	HP Ultra Mobile Wireless Mouse	H6F25AA
	HP Comfort Grip Wireless Mouse	H2L63AA
	HP 3-Button USB Laser Mouse	H4B81AA
	HP USB Travel Mouse	G1K28AA
	HP HDMI to DVI Adapter	F5A28AA
Memory	4GB 2666MHz DDR4	4VN05AA
	8GB 2666MHz DDR4	4VN06AA
	16GB 2666 MHz DDR4	4VN07AA
Power	HP 45W Smart AC Adapter 4.5mm	H6Y88AA
	HP 65W Slim AC Adapter	H6Y82AA
	HP 65W USB-C Power Adapter	3PN48AA
	HP 45W USB-C Power Adapter	1HE17AA
	HP 65W USB-C Power Adapter	1HE08AA
	HP Power Bank	N9F71AA
	HP USB-C Power Bank	2NA10AA
	HP 45W LC USB-C Power Adapter	1MZ01AA#ABA
Storage	HP External USB Optical Drive	F2B56AA
	HP 500GB 7200rpm HDD	F3B97AA
Security	HP Combination Lock	TOY15AA
	HP Essential Keyed Cable lock 12.3mm	TOY14AA
	HP Keyed Cable Lock 10mm	T1A62AA
	HP UltraSlim Keyed Cable Lock	T1A62AA
UCC	HP Conferencing Keyboard	K8P74AA
	HP Speaker Phone	K7V16AA
	HP Wired Headset	K7V17AA
Displays	HP ProDisplay P223 21.5-inch Monitor	X7R61AA
	HP ProDisplay P232 23-inch Monitor	K7X31AA
	HP ProDisplay P240va 23.8-inch Monitor	X3B48AA
	HP EliteDisplay E243 23.8-inch Monitor	1FH47AA
	HP EliteDisplay E243m 23.8-inch Collaboration Monitor	1FH48AA
	HP EliteDisplay E273 27-inch Monitor	1FH50AA



### **Summary of Changes**

Date of change:	Version History:		Description of change:
December 10, 2018	V1 to V2	Removed	Dock UltraSlim
December 12, 2018	V2 to V3	Removed	Phonewise Software
December 17, 2018	V3 to V4	Added	Environmental section
December 21, 2018	V4 to V5	Added	Skype in at a glance section
January 30, 2019	V5 to V6	Added	Storage section
March 7, 2019	V6 to V7	Updated	Passed MIL-STD
March 15, 2019	V7 to V8	Added	Processors
March 20, 2019	V8 to V9	Updated	Storage and drives
April 17, 2019	V9 to V10	Updated	MIL-STD
May 7, 2019	V10 to V11	Updated	At a glance section
June 11, 2019	V11 to V12	Added	HP Cloud Recovery
July 23, 2019	V12 to V13	Added	Speaker to Audio section
September 20, 2019	V13 to V14	Updated	Lock Slot and 250nits panel
October 11, 2019	V14 to V15	Added	DisplayPort™ 1.2 and i5-8365U Processor

Copyright © 2019 HP Development Company, L.P. The only warranties for HP products are set forth in the express limited warranty statements accompanying such products. Nothing herein should be construed as constituting an additional warranty. HP shall not be liable for technical or editorial errors or omissions contained herein.

Bluetooth is a trademark of its proprietor and used by HP Inc. under license. Intel, Core, Celeron and Intel vPro are trademarks of Intel Corporation or its subsidiaries in the U.S. and/or other countries. NVIDIA, the NVIDIA logo, and GeForce are trademarks and/or registered trademarks of NVIDIA Corporation in the U.S. and other countries. USB Type-C™ and USB-C™ are trademarks of USB Implementers Forum. ENERGY STAR is a registered trademark of the U.S. Environmental Protection Agency. Microsoft and Windows are either registered trademarks or trademarks of Microsoft Corporation in the United States and/or other countries.

